

TPC R&D at ASIA/MPI

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summary of 2004 work
plan of 2005
WorldWide TPC study
MPGD R&D in Japan

Work done in 2004

The first year of TPC study@ASIA

Hardware

MPI/TPC MWPC

beam test in JACEE solenoid (June)
cosmic test (Nov.)

triple GEM test chamber

beam test (Jun., Dec.)
GEM CERN/Fuchigami

MPI/TPC (MWPC -> triple GEM) (Dec.)

MPI/TPC

Comparison all kind of sensors in the same environment

MWPC, GEM, micromegas, ...

Software

Developing JUPITER based tracking w/ TPC geometry

re-establish the real requirements to tracker

resolution, 2track separation, extra pol.

TPC with MWPC

Accumulated experiences
Stable operation

Cathode readout -- broad image
resolution (ExB, ..)

2mm : small pitched anode wires
1mm : small gap between wires to cathode pads

Pad response @ 0 drift \rightarrow ~ 1.5 mm (due to gap length)
Diffusion behavior is as expected

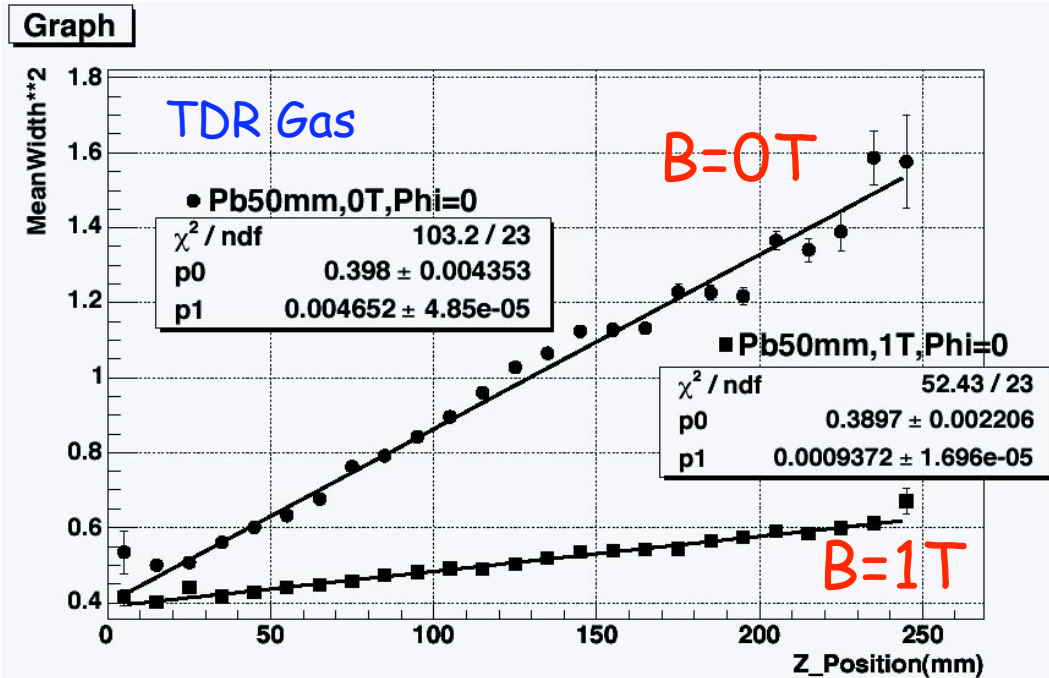
$$\sigma_{PRF} = \sqrt{(\sigma_{PRF}^0)^2 + C_D^2 z}$$

\uparrow
0 drift PRF

	$B = 0 T$	$B = 1 T$
σ_{PRF}^0 (mm)	1.44	1.45
C_D (mm/ \sqrt{cm})	0.50	0.22

Expected C_D @ $B=3T$ ~ 0.1 mm/ \sqrt{cm}

signal width ~ 2 mm @ 2.3m drift
enough for 2 track separation??



Resolution

$$\sigma_x \sim \sqrt{\sigma_0^2 + \frac{C_D^2}{N_e} z}$$

From fit

$$\begin{aligned} \sigma_0 &= 0.21 \text{ mm} \\ C_D/\sqrt{N_e} &= 0.048 \text{ mm}/\sqrt{\text{cm}} \quad (B = 1T) \\ &= 0.096 \text{ mm}/\sqrt{\text{cm}} \quad (B = 0T) \end{aligned}$$

preliminary

obtained "Ne" is ~ 40% of real Ne !!

"Huge" detector TPC

Max. drift length ~ 2.3m@B=3T

Ne 100%	$\sigma_x \sim 190 \text{ um}$
Ne 40%	$\sigma_x \sim 300 \text{ um}$
+ σ_0	$\sigma_x \sim 370 \text{ um}$

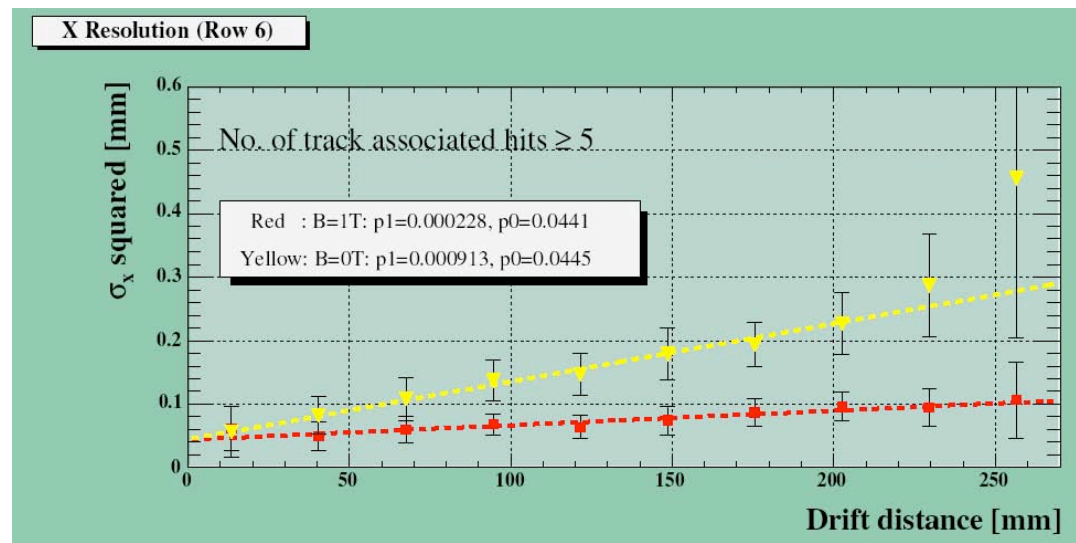
$C_D = 0.1 \text{ mm}/\sqrt{\text{cm}}$ TDR@B=3T

need better gas having smaller C_D
improve "Ne" or MPGD

improve resolution (S/N, corrections)

210 um is a little bit too large!

to achieve 150um : $C_D < 0.07 \text{ mm}/\sqrt{\text{cm}}$ w/ 100% Ne
 $\sigma_0 < 0.1 \text{ mm}$



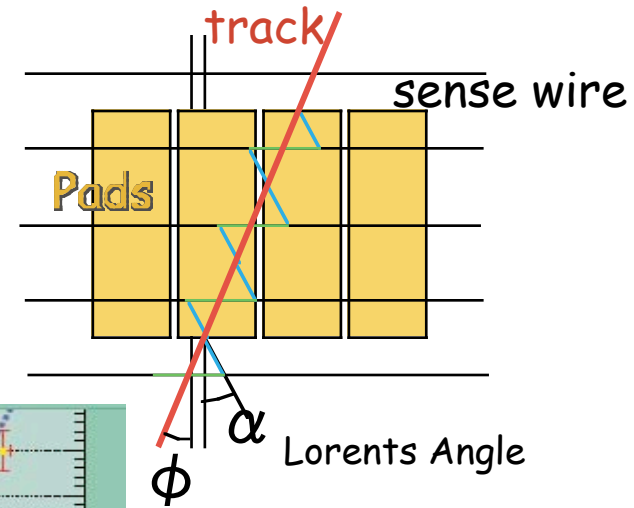
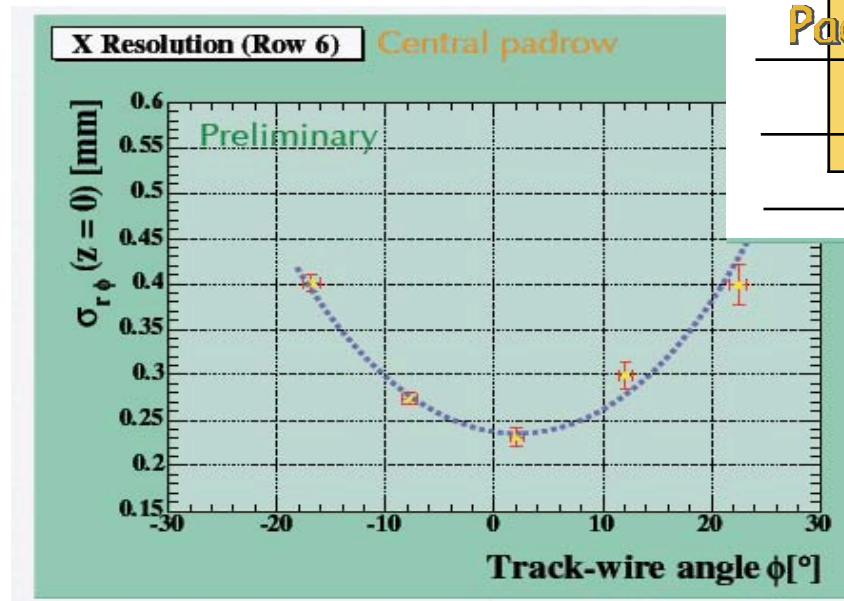
wire screening effect?

gain fluctuation?

due to tracking error?



Wire Angular effect(EXB) is not so bad
for 2mm pitch sense wire



We will finish analysis for MWPC-TPC data ASAP -->LCWS05

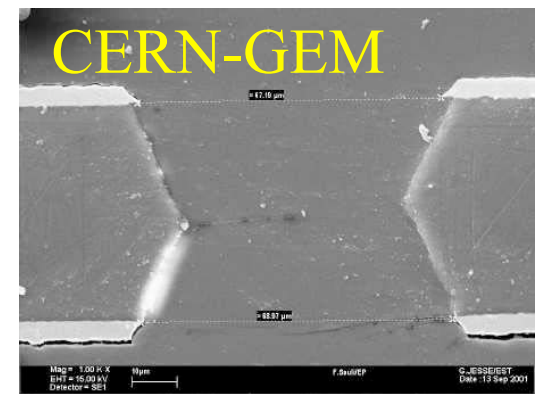
Using obtained parameters : Simulation study w/ MWPC-TPC

Study GEM using test chamber

GEM

CERN/Fuchigami show almost same performance

wet / dry(plasma) etching



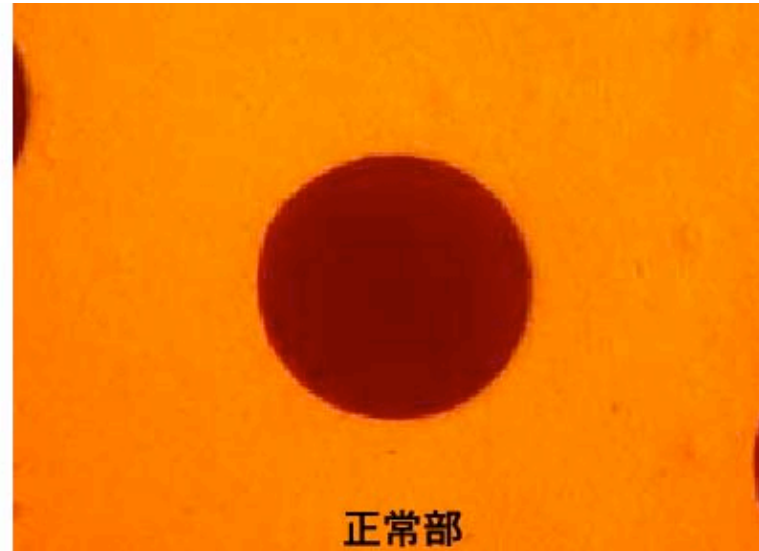
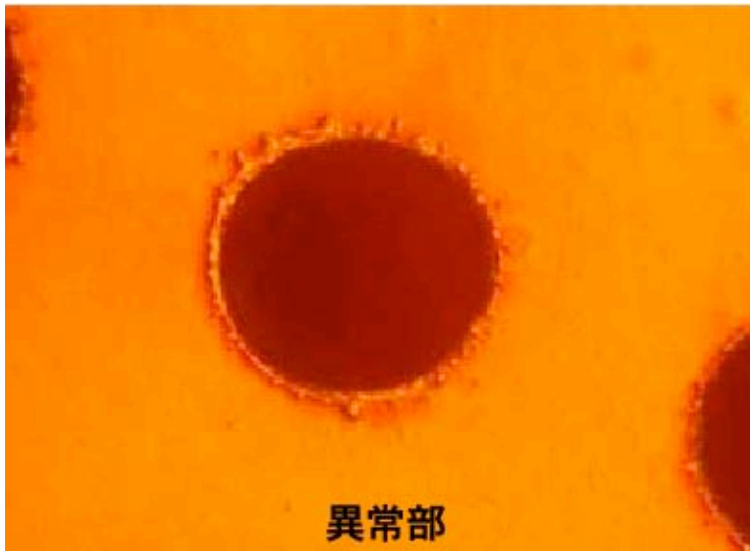
Overdose test (accidental) @ Hiroshima

dose > 1 MHz/mm² for 10usec every 100msec

current draw when beam come

(not constant drawing)

same thing happen both CERN/Fuchigami



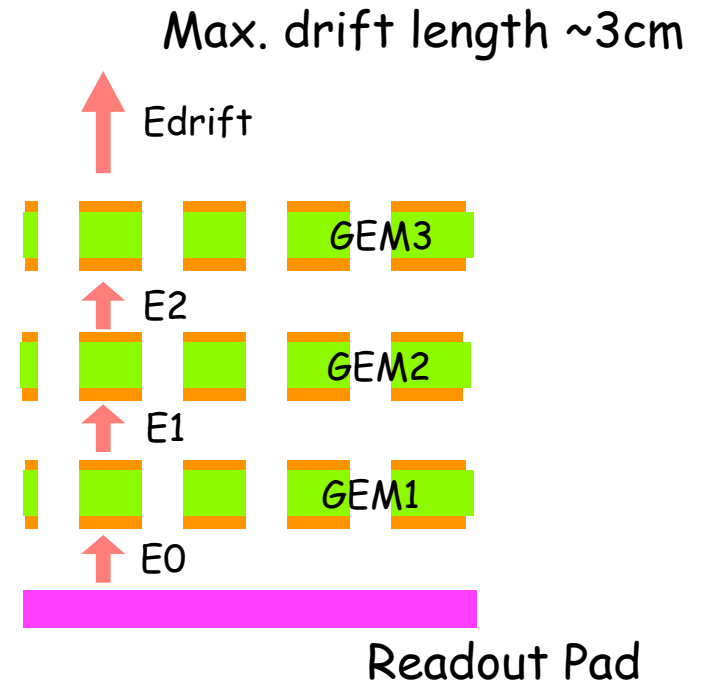
Systematic study of resolution (defocusing effect)

V_{GEM}

induction gap field

transfer gap field

Analysis on going.



Dean's suggestion: geometric mean

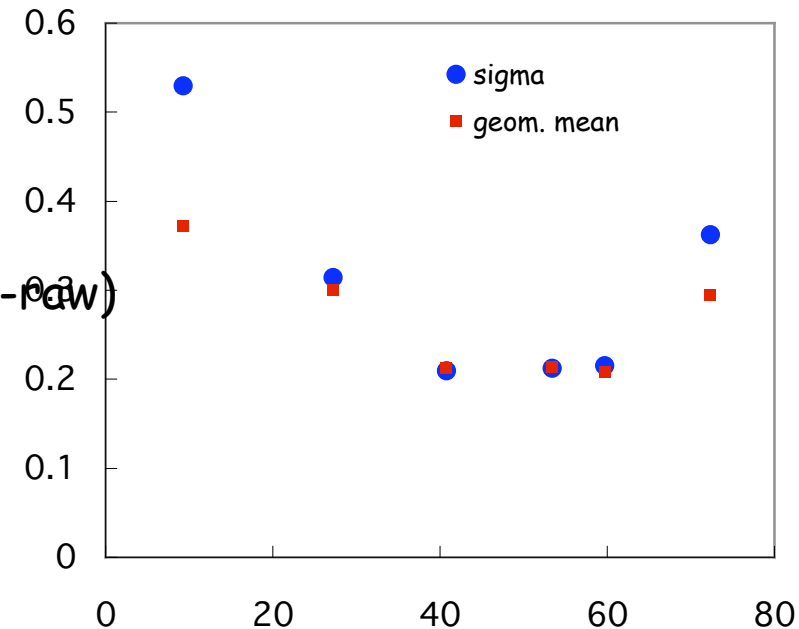
check of "geometric mean" for resolution
use 6 pad-rows

σ_6 residual using 6 pad-rows

σ_5 residual using 5 pad-rows (w/o target pad-row)

$$\sigma_{geom.} = \sqrt{\sigma_5 \sigma_6}$$

$$\sigma_{sigma} = \sqrt{\sigma_5^2 - \sigma_{track}^2}$$



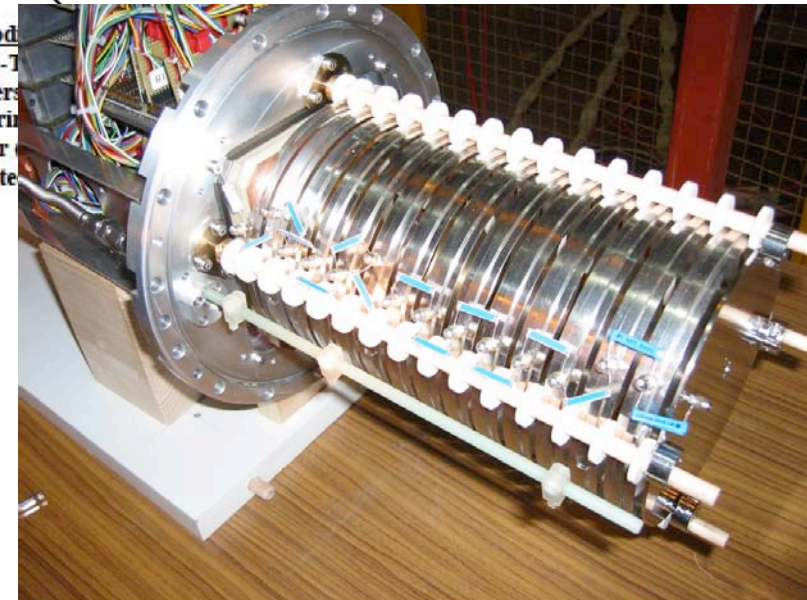
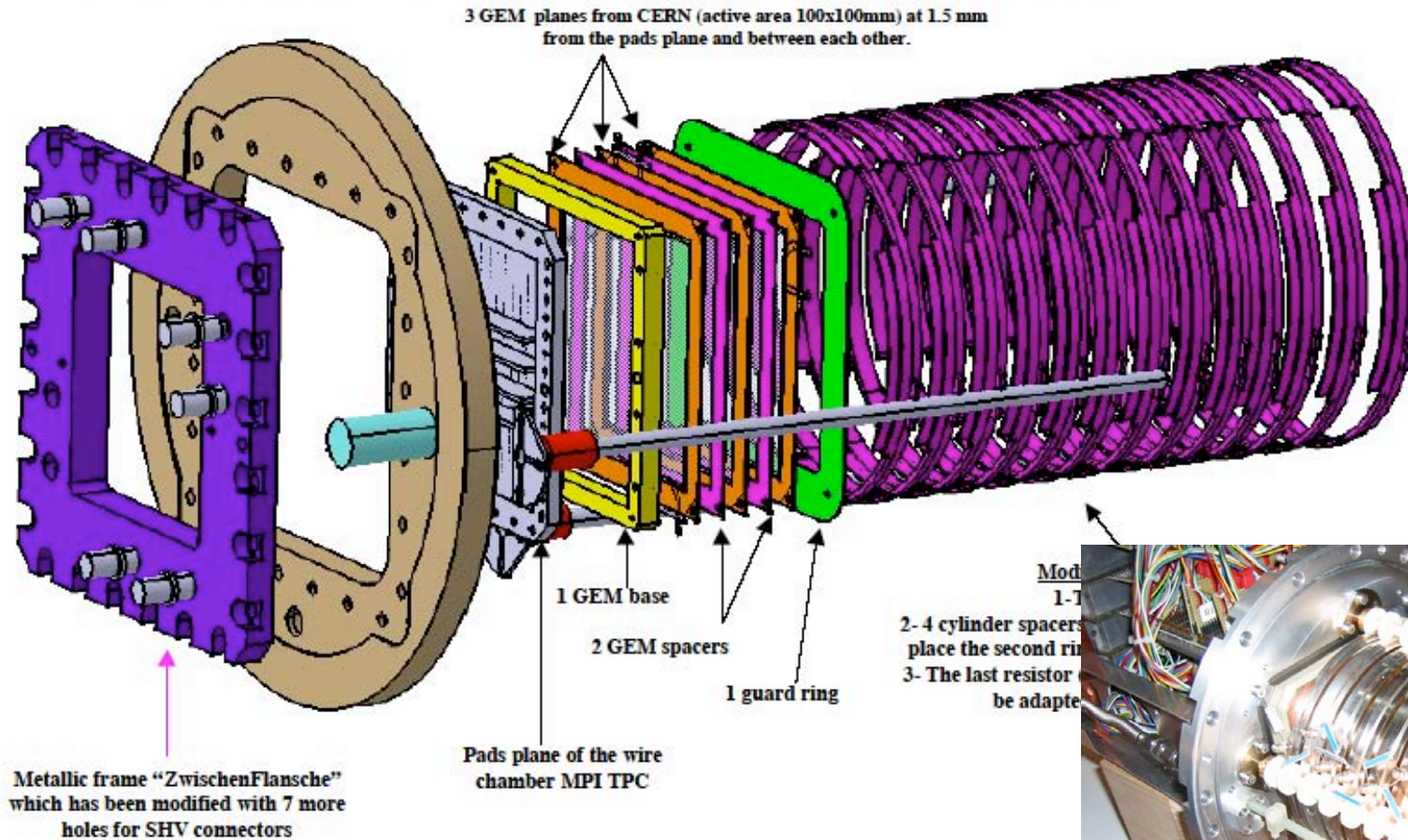
GEM installation into MPI/TPC

Exploded view of the modified MPI TPC equipped with 3 GEM planes

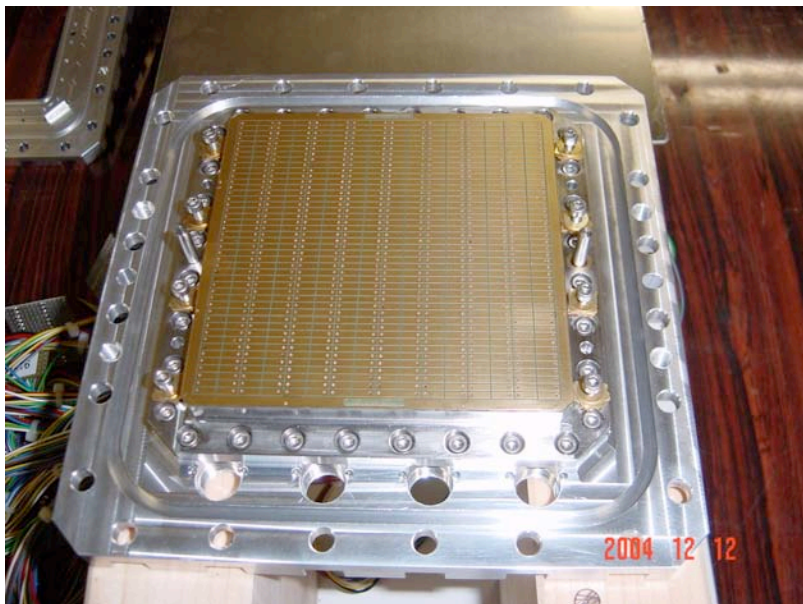
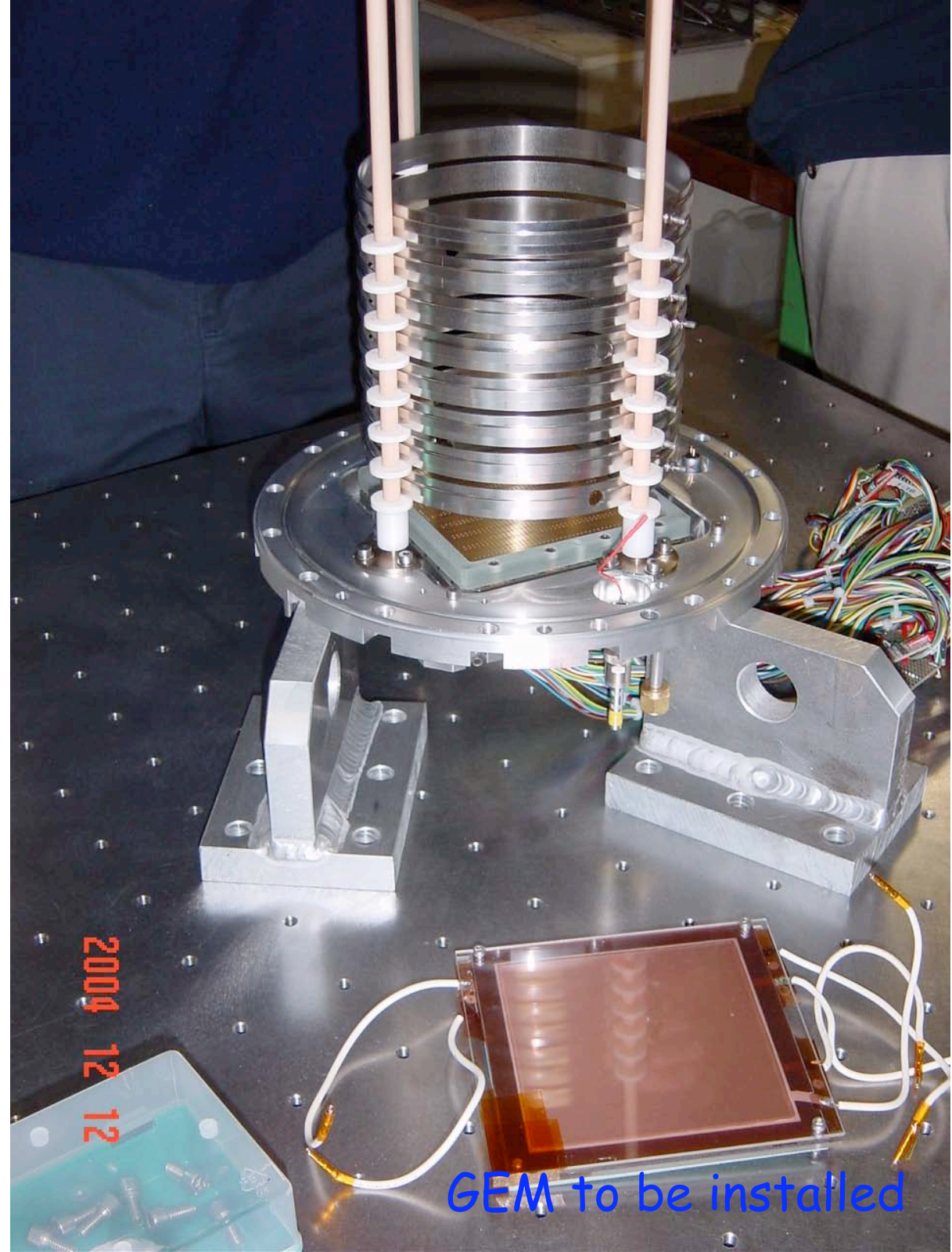
3 GEMs are mounted at a pitch of 1.5 mm. The metallic frame has to be modified (Drawing 1).
One epoxy GEM base 9 mm thick (yellow), 2 spacers 0.5 mm (purple) and a guard ring have to be machined (Drawing 2, 3 and 4).

Comments:

- 1- The pitch between GEM can be increased by introducing additional spacer
- 2- The reduction from 3 GEMs to 2 GEMs can be obtained by removing one plane and by adjusting the field (last resistor)



Field Cage modification
Remove 1-st ring of FC



New "ZwischenFlansche"
having extra HV connectors for GEM

GEM to be installed

1st track observed from MPI/GEM-TPC

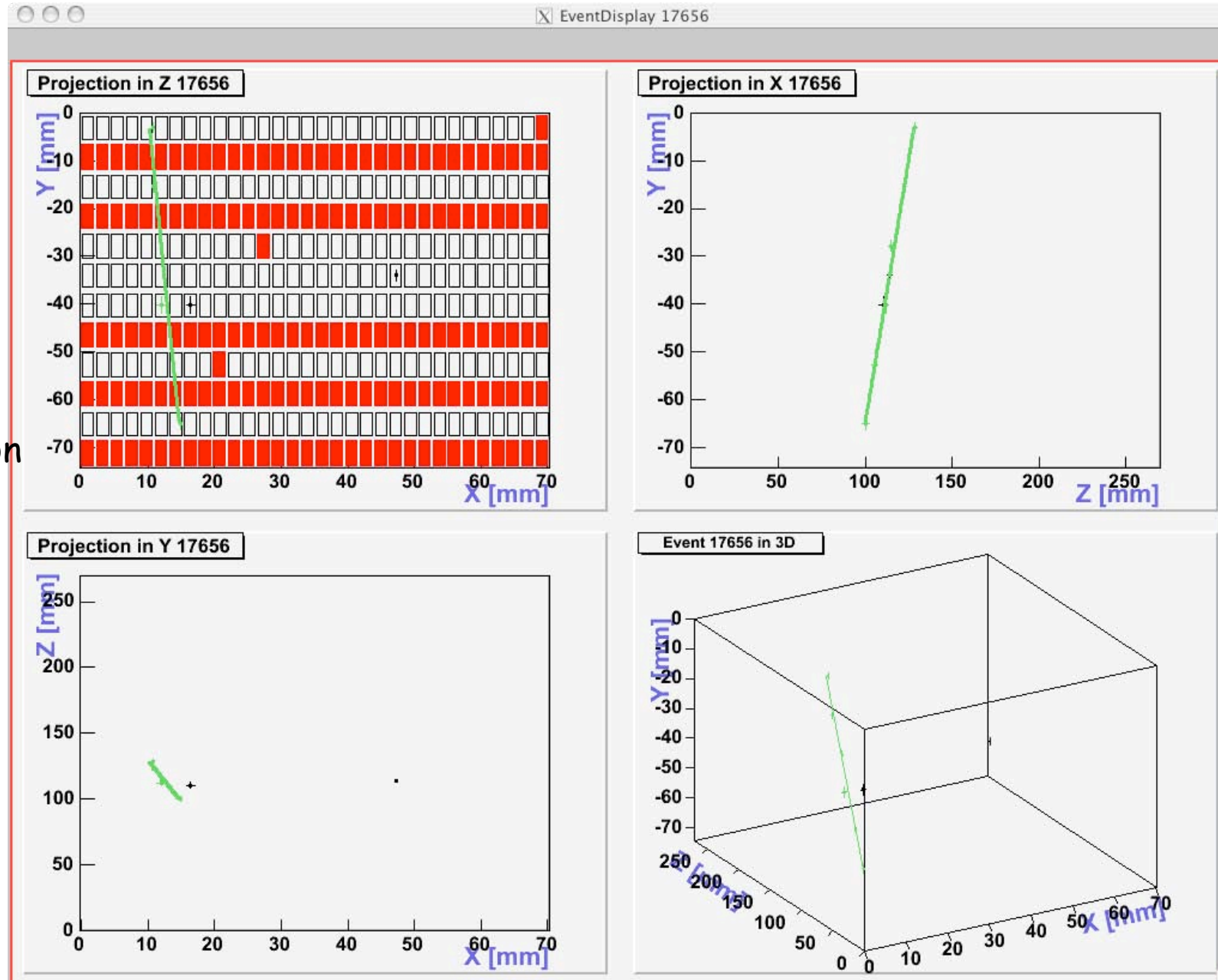
triple CERN GEM
VGEM = 320V
E_{trans./ind.} = 2kV/cm

No Mag. Field

GAS : TRD

Trying to take
cosmic data.

but DAQ trouble &
New year's vacation
....



Plan for 2005

MPI/TPC w/ MPGD beam test(Direct comparison of sensors)

We are proposing beam tests for GEM-TPC and Micromegas-TPC
in spring of 2005 (Apr.~ ?)

JACEE magnet

GEM-TPC : installed in TPC and test by cosmic

* Pad(2x6mm) is too wide !?

we may build new pad plane (1x6? mm)

CERN/Fuchigami, small pitch GEM(50/30)?

Micromegas : under preparation by Orsay,Saclay,Carlton
w/ resistive foil

Cosmic Ray test @Cryogenic center

General issue

Pad size optimization

Gas study

realistic MPGD /readout pad (sector) design

Simulations

Effort to WW TPC study

Preparation for WW large/middle prototype TPC
submit several proposals to JSPS, US-Japan
not sure we have money

The basic plan

Build TPC within JACEE type super-conducting Solenoid Magnet

Magnet (existing JACEE/ new one)

Size of Magnet

Field Strength

merit

Field Cage

Readout electronics

replaceable endplate(MPGD & readout pad) prepared by each group



Magnet

portable
stand alone operation

Existing JACEE

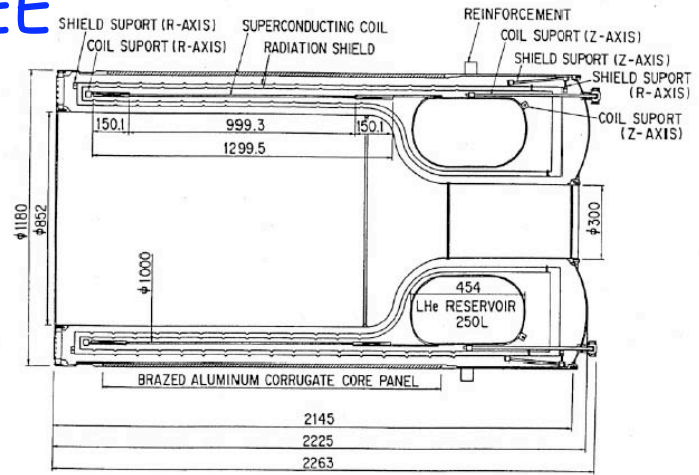
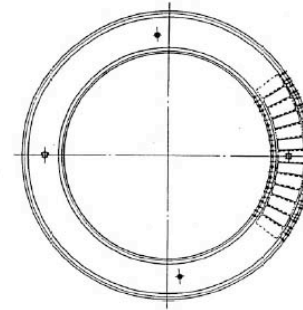
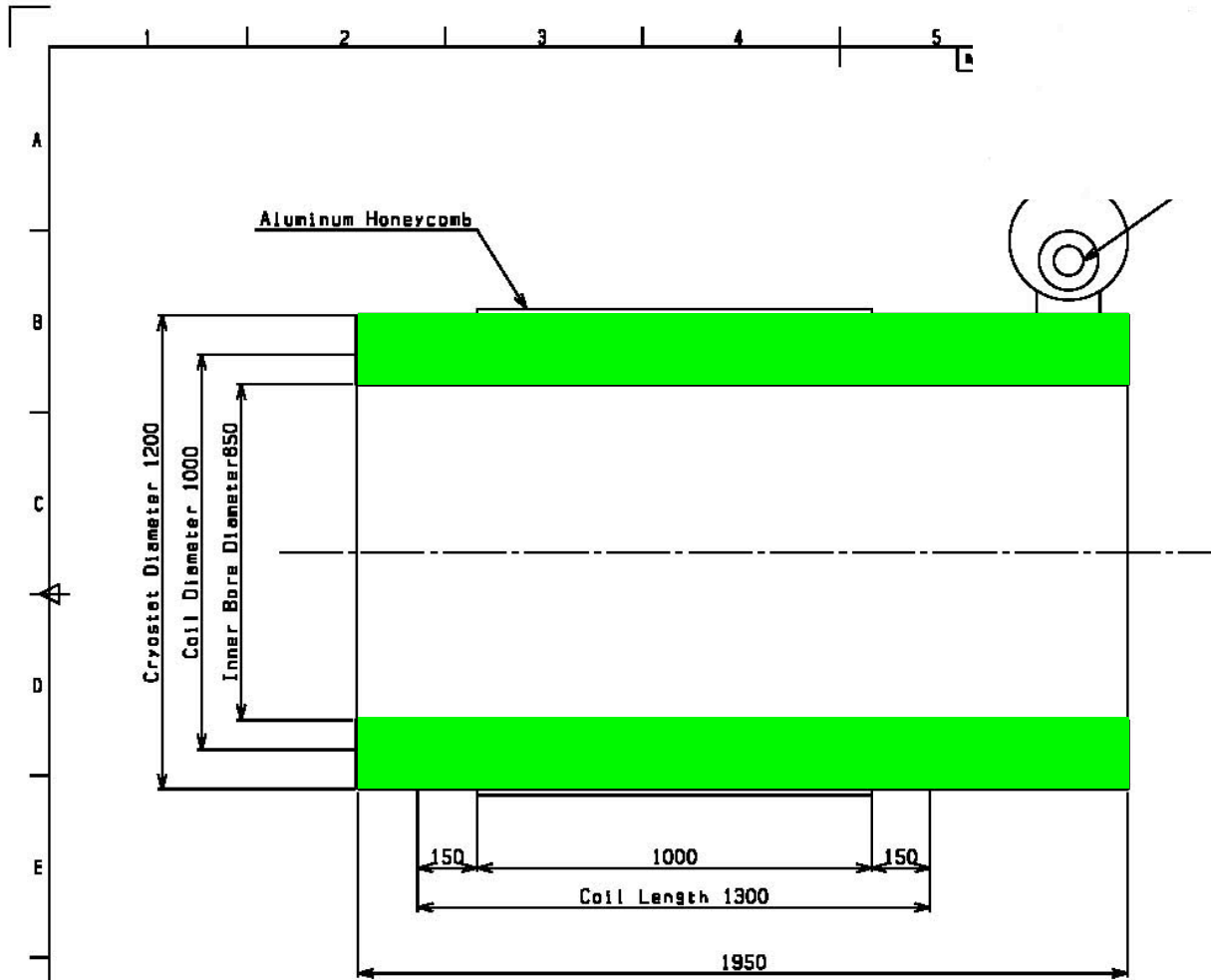


Fig. 1 Cross sectional view of the Super Jacee Magnet.



Inner diameter 85cm

Max. B 1.2T

0.2 rad. length

non-uniformity of B

Coil exist
but nothing else

Money!!

Item No.	Quantity	Title/Rev. description, material, dimension etc.	Article No./Reference
Designed by	Checked by	Approved by - date	File name
BP00-0000			
BESS-Polar Solenoid		KEK High Energy Accelerator Research Organization	
		Edits	Sheet
		n	n/n

MPGD R&D in Japan

A lot of work by CNS(Tokyo U.) and RIKEN w/ Fuchigami Micro co.

Processing method

Plasma etching

easy to make large area
but minimum pitch is $\sim 90 \mu\text{m}$

Laser

50(pitch)/30(hole) possible

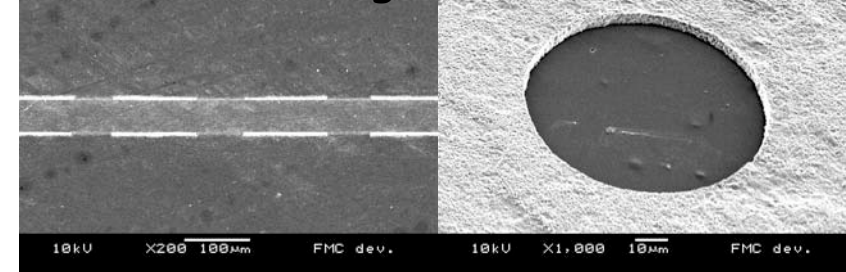
may improve defocusing effect
limit of gas gain
(reduce #of layer?)

Ni plating on Cu

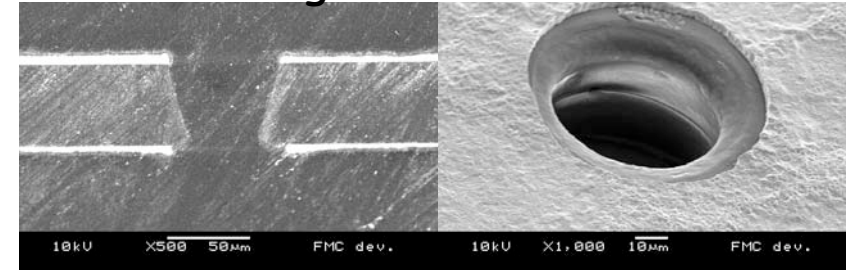
harden the edge of hole

CO₂ Laser etching by RIKEN

Chemical etching for Cu



Laser etching from one side



Laser etching from the other side

